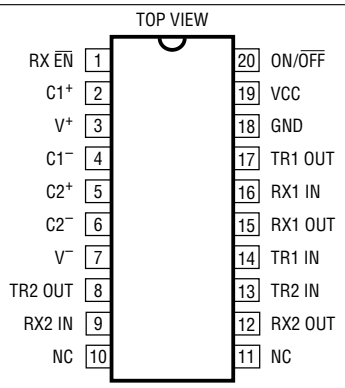
ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC}) 6V
Input Voltage
  Driver ..... $-0.3V$ to $V_{CC} + 0.3V$
  Receiver ..... $-25V$ to $25V$
  Digital Input ..... $-0.3V$ to $V_{CC} + 0.3V$
Output Voltage
  Driver ..... $-25V$ to $25V$
  Receiver ..... $-0.3V$ to $V_{CC} + 0.3V$

Short-Circuit Duration
  V^+ ..... 30 sec
  V^- ..... 30 sec
  Driver Output ..... Indefinite
  Receiver Output ..... Indefinite
Operating Temperature Range
  LTC1384C ..... 0°C to 70°C
  LTC1384I ..... –40°C to 85°C
Storage Temperature Range ..... –65°C to 150°C
Lead Temperature (Soldering, 10 sec) ..... 300°C

PACKAGE/ORDER INFORMATION

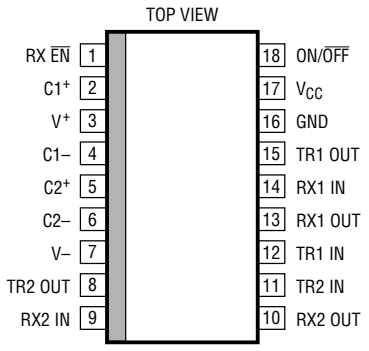


G PACKAGE
20-LEAD SSOP

T_{JMAX} = 125°C, θ_{JA} = 135°C/W

ORDER PART NUMBER

LTC1384CG
LTC1384IG



N PACKAGE
18-LEAD PDIP

T_{JMAX} = 125°C, θ_{JA} = 65°C/W

SW PACKAGE
18-LEAD PLASTIC SO

T_{JMAX} = 125°C, θ_{JA} = 85°C/W

ORDER PART NUMBER

LTC1384CN
LTC1384CSW
LTC1384IN
LTC1384ISW

Consult LTC Marketing for parts specified with wider operating temperature ranges.

DC ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range. V_{CC} = 5V, C1 = C2 = C3 = C4 = 0.1µF, $V_{ON/\overline{OFF}} = V_{CC}$, RX $\overline{EN}$ = 0V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Any Driver						
Output Voltage Swing	3k to GND	Positive ●	5.0	7.0		V
		Negative ●	–5.0	–6.5		V
Logic Input Voltage Level	Input Low Level (V_{OUT} = High)	●		1.4	0.8	V
	Input High Level (V_{OUT} = Low)	●	2.0	1.4		V
Logic Input Current	$V_{IN} = V_{CC}$	●			5	µA
	V_{IN} = 0V	●		–20	–40	µA
Output Short-Circuit Current	V_{OUT} = 0V		±9	±12		mA
Output Leakage Current	Shutdown or V_{CC} = 0V (Note 3), V_{OUT} = ±10V	●		±10	±500	µA
Any Receiver						
Input Voltage Thresholds	Input Low Threshold	●	0.8	1.3		V
	Input High Threshold	●		1.7	2.4	V
Hysteresis		●	0.1	0.4	1	V
Input Resistance	$-10V \le V_{IN} \le 10V$		3	5	7	kΩ
Output Voltage	Output Low, $I_{OUT} = -1.6mA$ (V_{CC} = 5V)	●		0.2	0.4	V
	Output High, $I_{OUT} = 160\mu A$ (V_{CC} = 5V)	●	3.0	3.2		V

DC ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range. V_{CC} = 5V, C1 = C2 = C3 = C4 = 0.1µF, $V_{ON/\overline{OFF}}$ = V_{CC}, RX $\overline{EN}$ = 0V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Output Short-Circuit Current	Sinking Current, V_{OUT} = V_{CC}		–15	–40		mA
	Sourcing Current, V_{OUT} = 0V		10	20		mA
Output Leakage Current	$\overline{EN}$ = V_{CC}, 0V ≤ V_{OUT} ≤ V_{CC}	●		1	10	µA
Power Supply Generator						
V^+ Output Voltage	I_{OUT} = 0mA			8.0		V
	I_{OUT} = 8mA			7.5		V
V^- Output Voltage	I_{OUT} = 0mA			–8.0		V
	I_{OUT} = –8mA			–7.0		V
Supply Rise Time	Shutdown to Turn-On			0.2		ms
Power Supply						
V_{CC} Supply Current	No Load (Note 2), 0°C to 70°C	●		0.22	0.5	mA
	No Load (Note 2), –40°C to 85°C	●		0.35	1.0	mA
Supply Leakage Current (V_{CC})	Shutdown (Note 3)	●		35	50	µA
Digital Input Threshold Low		●		1.4	0.8	V
Digital Input Threshold High		●	2.0	1.4		V

AC CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range. V_{CC} = 5V, C1 = C2 = C3 = C4 = 0.1µF, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Slew Rate	R_L = 3k, C_L = 51pF			8	30	V/µs
	R_L = 3k, C_L = 2500pF		3	5		V/µs
Driver Propagation Delay (TTL to RS232)	t_{HLD} (Figure 1)	●		2	3.5	µs
	t_{LHD} (Figure 1)	●		2	3.5	µs
Receiver Propagation Delay (RS232 to TTL)	t_{HLR} (Figure 2)	●		0.3	0.8	µs
	t_{LHR} (Figure 2)	●		0.3	0.8	µs

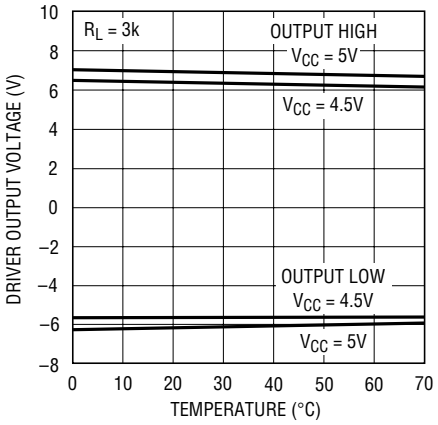
Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

Note 2: Supply current is measured with driver and receiver outputs unloaded.

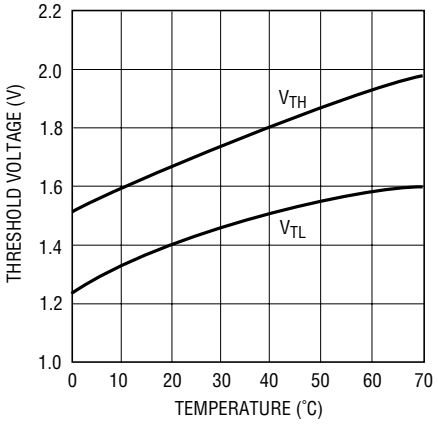
Note 3: Measurements made in the Shutdown mode are performed with $V_{ON/\overline{OFF}}$ = 0V.

TYPICAL PERFORMANCE CHARACTERISTICS

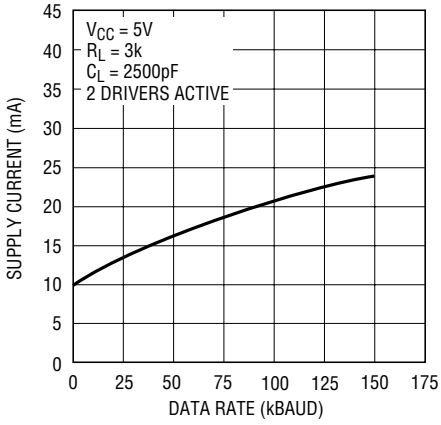
Driver Output Voltage vs Temperature



Receiver Input Thresholds vs Temperature

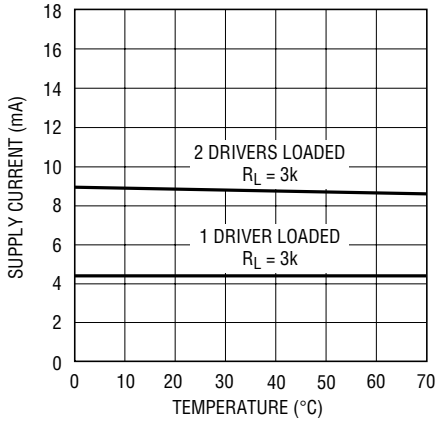


Supply Current vs Data Rate



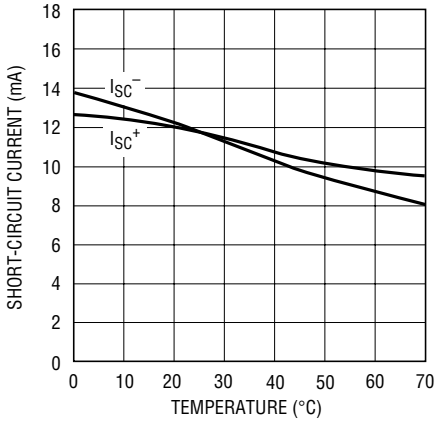
TYPICAL PERFORMANCE CHARACTERISTICS

V_{CC} Supply Current vs Temperature



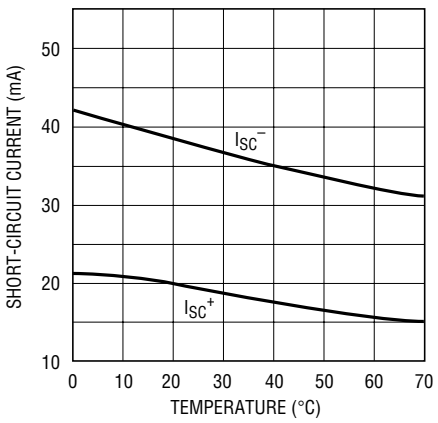
LTC1384 • TPC04

Driver Short-Circuit Current vs Temperature



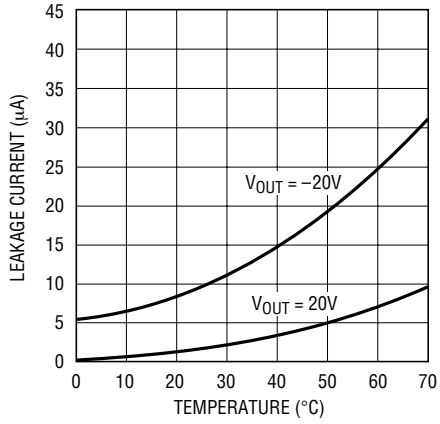
LTC1384 • TPC05

Receiver Short-Circuit Current vs Temperature



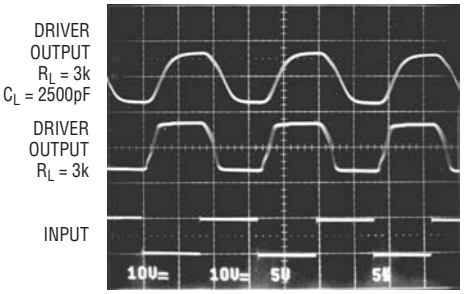
LTC1384 • TPC06

Driver Leakage in Shutdown vs Temperature



LTC1384 • TPC07

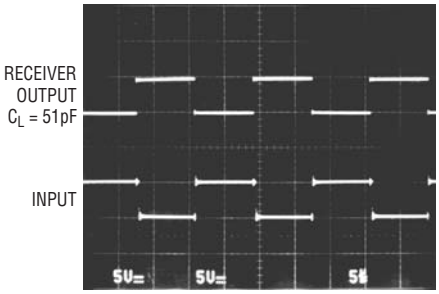
Driver Output Waveforms



LTC1384 • TPC08

5µs/DIV

Receiver Output Waveforms



LTC1384 • TPC09

5µs/DIV

PIN FUNCTIONS

V_{CC}: 5V Input Supply Pin. This pin should be decoupled with a 0.1μF ceramic capacitor.

GND: Ground Pin.

ON/$\overline{OFF}$: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode independent of the RX $\overline{EN}$ pin. The supply current of the device drops to 35μA (two receivers alive) and both driver outputs are forced into three-state.

RX $\overline{EN}$: TTL/CMOS Compatible Receiver Enable Pin. A logic high forces the receiver outputs into three-state. A logic low enables the receiver outputs.

V^+: Positive Supply Output (RS232 Drivers). $V^+ \cong 2V_{CC} - 2V$. This pin requires an external capacitor C = 0.1μF for charge storage. The capacitor may be tied to ground or V_{CC}. With multiple devices, the V^+ and V^- pins may share a common capacitor. For large numbers of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V^-: Negative Supply Output (RS232 Drivers). $V^- \cong -(2V_{CC} - 2V)$. This pin requires an external capacitor C = 0.1μF for charge storage.

$C1^+$, $C1^-$, $C2^+$, $C2^-$: Commutating Capacitor Inputs. These pins require two external capacitors C = 0.1μF: one from $C1^+$ to $C1^-$ and another from $C2^+$ to $C2^-$. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 2Ω.

TR IN: RS232 Driver Input Pins. Inputs are TTL/CMOS compatible. The inputs of unused drivers can be left unconnected since 300k input pull-up resistors to V_{CC} are included on chip. To minimize power consumption, the internal driver pull-up resistors are disconnected from V_{CC} in the Shutdown mode.

TR OUT: Driver Outputs at RS232 Voltage Levels. Outputs are in a high impedance state when in the Shutdown or V_{CC} = 0V. The driver outputs are protected against ESD to ±10kV for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to ±25V without damage. The receiver inputs are protected against ESD to ±10kV for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. A logic high at RX $\overline{EN}$ puts the outputs into three-state.

SWITCHING TIME WAVEFORMS

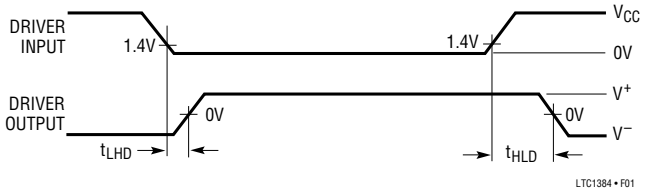


Figure 1. Driver Propagation Delay Timing

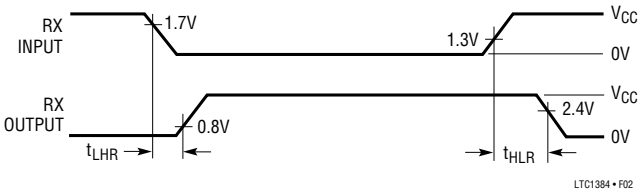
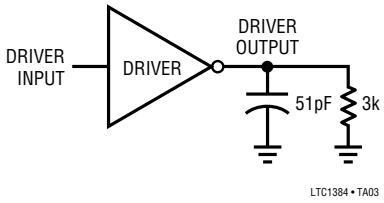


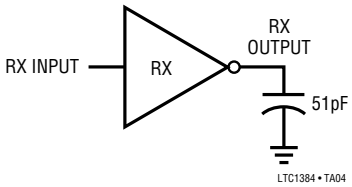
Figure 2. Receiver Propagation Delay Timing

TEST CIRCUITS

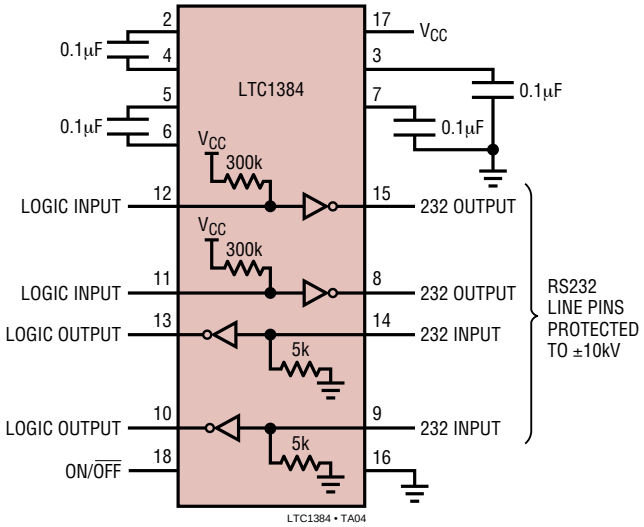
Driver Timing Test Load



Receiver Timing Test Load

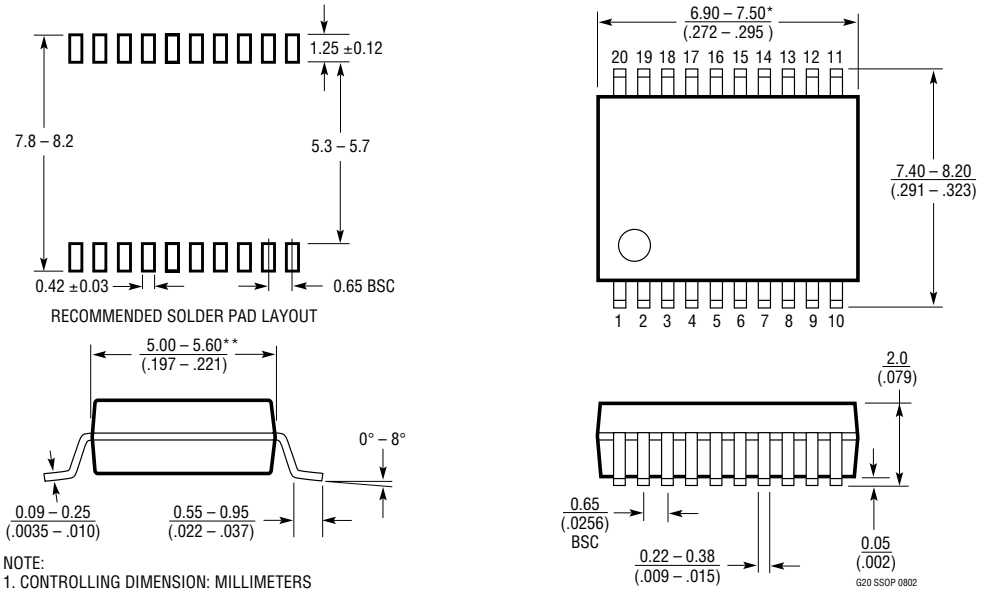


ESD Test Circuit



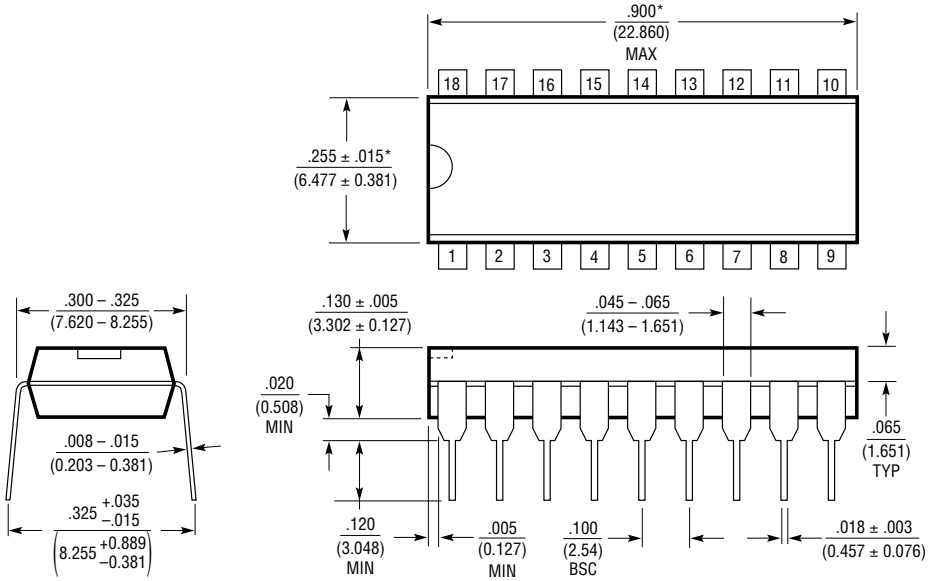
PACKAGE DESCRIPTION

G Package
20-Lead Plastic SSOP (5.3mm)
(Reference LTC DWG # 05-08-1640)



NOTE:
1. CONTROLLING DIMENSION: MILLIMETERS
2. DIMENSIONS ARE IN $\frac{\text{MILLIMETERS}}{(\text{INCHES})}$
3. DRAWING NOT TO SCALE
*DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .152mm (.006") PER SIDE
**DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED .254mm (.010") PER SIDE

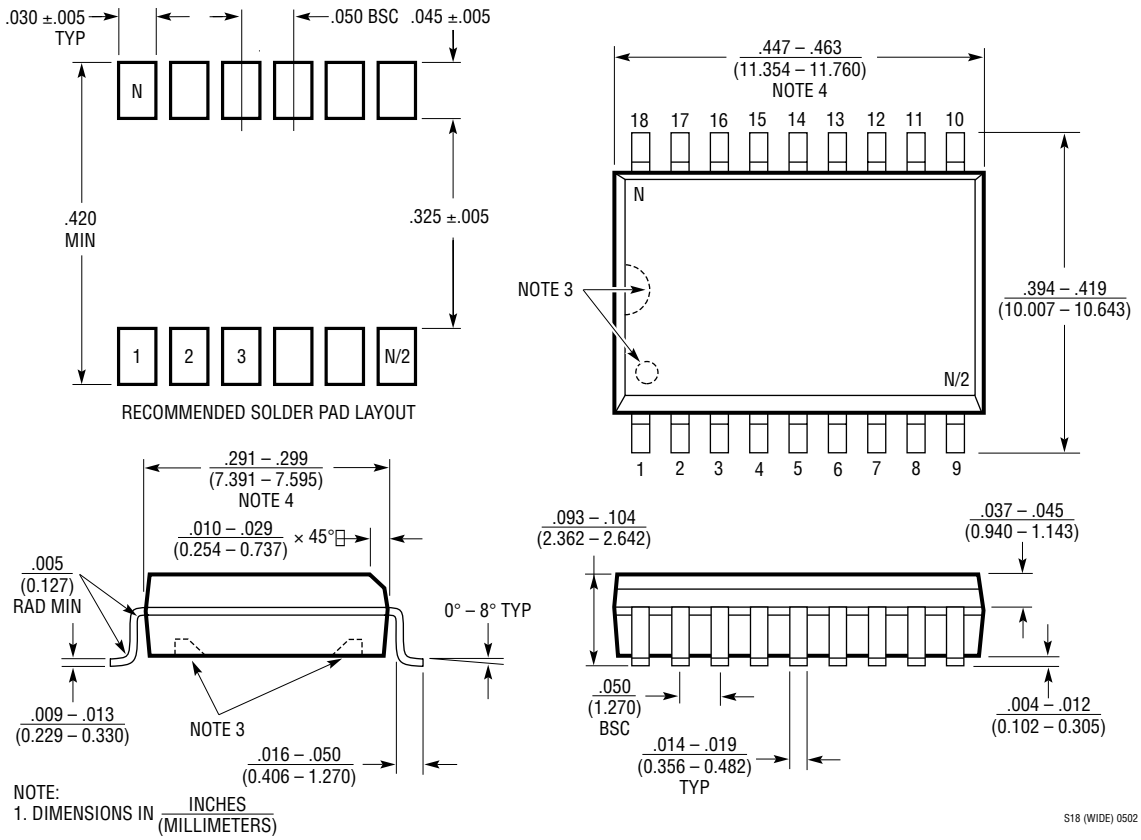
N Package
18-Lead PDIP (Narrow .300 Inch)
(Reference LTC DWG # 05-08-1510)



NOTE:
1. DIMENSIONS ARE $\frac{\text{INCHES}}{\text{MILLIMETERS}}$
*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

PACKAGE DESCRIPTION

SW Package
18-Lead Plastic Small Outline (Wide .300 Inch)
(Reference LTC DWG # 05-08-1620)



NOTE:
1. DIMENSIONS IN $\frac{\text{INCHES}}{(\text{MILLIMETERS})}$
2. DRAWING NOT TO SCALE
3. PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS. THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS
4. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1780/LT1781	5V, 2 Driver, 2 Receiver RS232 Transeivers	±15kV ESD per IEC 1000-4
LTC1382	5V, 2 Driver, 2 Receiver RS232 Transceiver	220μA Supply Current, 0.2μA in Shutdown
LTC1383	5V, 2 Driver, 2 Receiver RS232 Transceiver	220μA Supply Current, Narrow 16-pin SO
LTC1385	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	220μA Supply Current, 2 Receivers Active in Shutdown
LTC1386	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	220μA Supply Current, Narrow 16-pin SO

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